# Chip resistor networks MNR02 (1005 × 2 size)

### Features

1) Extremely small and light

Area ratio is 60% smaller than that of chip 1616 (MNR12), while weight ratio has been cut 75%.

2) High-density mounting

Can be mounted even more densely than two 1005 chips (MCR01). Also, the cost of mounting has been reduced.

- 3) Compatible with a wide range of mounting equipment.
  - Squared corners make it excellent for mounting using image recognition devices.
- 4) Convex electrodes

Easy to check the fillet after soldering is finished.

5) ROHM resistors have obtained ISO-9001 certification.

Design and specifications are subject to change without notice. Carefully check the specification sheet before using or

### Ratings

ordering it.

Item	Conditions	Specifications
Rated power	Power must be derated according to the power derating curve in Figure 1 when ambient temperature exceeds 70°C.   **Bod of the power derating curve in Figure 1 when ambient temperature exceeds 70°C.  **Bod of the power derating curve in Figure 1 when ambient temperature exceeds 70°C.  **Bod of the power derating curve in Fig. 1	0.063W (1 / 16W) at 70°C
Rated voltage	The voltage rating is calculated by the following equation. If the value obtained exceeds the limiting element voltage, the voltage rating is equal to the maximum operating voltage. $E : Rated \ voltage \ (V)$ $E = \sqrt{P \times R} \qquad P : Rated \ power \ (W)$ $R : Nominal \ resistance \ (\Omega)$	Limiting element voltage 25V
Nominal resistance	See <u>Table 1</u> .	
Operating temperature		–55°C to +125°C



## Table 1

Resistance tolerance	Resistanc (Ω)	J	Resistance temperature coefficient (ppm / °C)
J (±5%)	10≤R≤1M	(E24)	±300

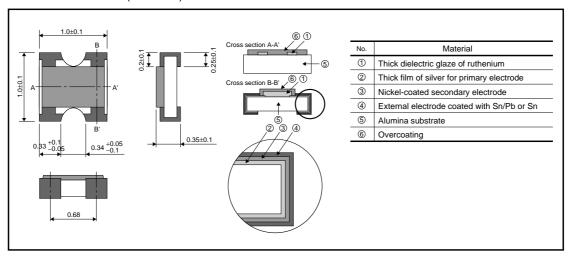
<sup>•</sup>Before using components in circuits where they will be exposed to transients such as pulse loads (short-duration, high-level loads), be certain to evaluate the component in the mounted state. In addition, the reliability and performance of this component cannot be guaranteed if it is used with a steady state voltage that is greater than its rated voltage.

## Characteristics

Items	Guaranteed value	Test conditions (IIC C 5201.1)	
items	Resistor type	Test conditions (JIS C 5201-1)	
Resistance	J:±5%	JIS C 5201-1 4.5	
Variation of resistance with temperature	See <u>Table.1</u>	JIS C 5201-1 4.8 Measurement : -55 / +25 / +125°C	
Overload	± (2.0%+0.1Ω)	JIS C 5201-1 4.13 Rated voltage (current) ×2.5, 2s. Limiting Element Voltage×2: 50V	
Solderability	A new uniform coating of minimum of 95% of the surface being immersed and no soldering damage.	JIS C 5201-1 4.17 Rosin-Ethanol (25%WT) Soldering condition : 235±5°C Duration of immersion : 2.0±0.5s.	
Resistance to soldering heat	$\pm \ (1.0\% + 0.05\Omega)$ No remarkable abnormality on the appearance.	JIS C 5201-1 4.18 Soldering condition : 260±5°C Duration of immersion : 10±1s.	
Rapid change of temperature	± (1.0%+0.05Ω)	JIS C 5201-1 4.19 Test temp. : –55°C~+125°C 5cyc	
Damp heat, steady state	± (3.0%+0.1Ω)	JIS C 5201-1 4.24 40°C, 93%RH Test time : 1,000h~1,048h	
Endurance at 70°C	± (3.0%+0.1Ω)	JIS C 5201-1 4.25.1 Rated voltage (current), 70°C 1.5h: ON – 0.5h: OFF Test time: 1,000h~1,048h	
Endurance	± (3.0%+0.1Ω)	JIS C 5201-1 4.25.3 125°C Test time: 1,000h~1,048h	
$\pm \text{ (1.0\%+0.05}\Omega)$ Resistance to solvent		JIS C 5201-1 4.29 23±5°C, Immersion cleaning, 5±0.5min. Solvent : 2-propanol	
Bend strength of the end face plating	$\pm$ (1.0%+0.05 $\Omega$ ) Without mechanical damage such as breaks.	JIS C 5201-1 4.33	

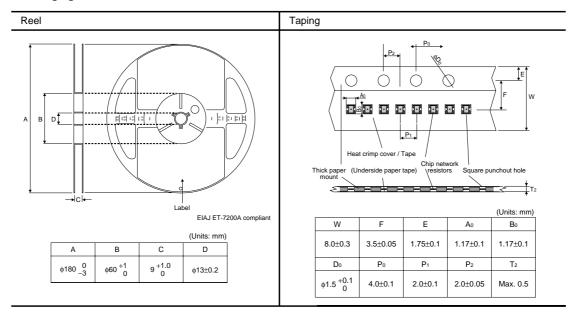


# ●External dimensions (Units: mm)

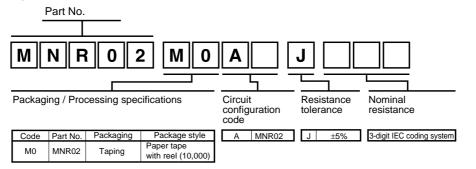


# ●Equivalent circuit

# Packaging



# Product designation



### Electrical characteristics

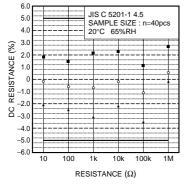


Fig.2 Resistance

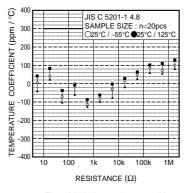


Fig.3 Variation resistance with temperature

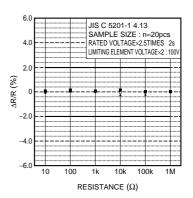


Fig.4 Overload

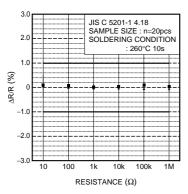


Fig.5 Resistance to soldering heat

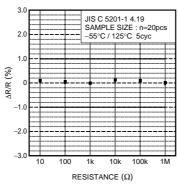


Fig.6 Rapid change of temperature

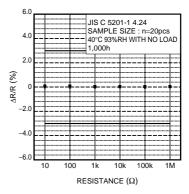


Fig.7 Damp heat, steady state

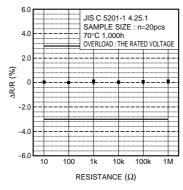


Fig.8 Endurance at 70°C

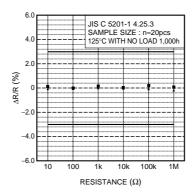


Fig.9 Endurance